



Nuvo-7000LP Series

Intel® 8th-Gen Coffee Lake Core™ i7/ i5/ i3 Fanless Controller with 6x GbE Ports, MeziO™ Interface and Low-profile Chassis



Key Features

- Intel® 8th-Gen Core™ i hexa-core 35W/ 65W LGA1151 CPU
- Low-profile chassis with hot-swappable 2.5" HDD/ SSD tray
- MeziO™ interface for easy function expansion
- Rugged, -25°C to 70°C fanless operation
- Up to 6x GigE ports, supporting 9.5 KB jumbo frame
- M.2 2280 M key socket (Gen3 x4) supporting NVMe SSD or Intel® Optane™ memory
- 4x USB 3.1 Gen2 ports and 4x USB 3.1 Gen1 ports
- VGA/ DVI/ DP triple independent display, supporting 4K2K resolution

Introduction

Introducing Neosys Technology's 2018 flagship rugged fanless controllers, the new Nuvo-7000 series, powered by Intel® 8th-Gen Core™ i processors with up to 6-core/ 12-thread architecture that offer a significant performance improvement over previous 6th or 7th-Gen platforms.

Nuvo-7000LP series is a derivative of Nuvo-7000 series that features the same level of ruggedness and versatility in a 79 mm low-profile chassis. In addition to effective fanless design, proprietary MeziO™ interface and plethora of on-board I/O interfaces, Nuvo-7000LP series features one front-accessible, hot-swappable HDD/ SSD tray which can be configured as RAID 0/1 when combined with the internal SATA port. It also leverages cutting-edge M.2 NVMe SSD technology for over 2000MB/s disk read/ write speed, or install an Intel® Optane™ memory for the ultimate system acceleration.

Neosys Nuvo-7000LP series consolidates the latest Intel hexa-core CPU, high-speed I/O interfaces, super-fast disk access and flexible storage configuration to form a high-performance ruggedized embedded controller. In addition, you can also take advantage of the built-in MeziO™ interface to add on modules for application-specific I/Os.

Specifications

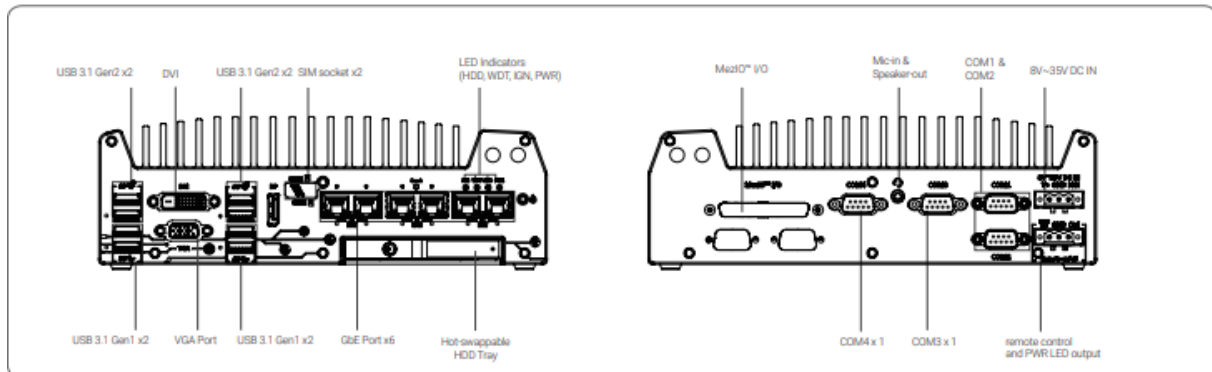
System Core		Expansion Bus	
Processor	Supporting Intel® 8th-Gen Coffee Lake CPU (LGA1151 socket, 35W/ 65W TDP) - Intel® Core™ i7-8700/ i7-8700T - Intel® Core™ i5-8500/ i5-8500T - Intel® Core™ i3-8100/ i3-8100T - Intel® Pentium® G5400/ G5400T - Intel® Celeron® G4900/ G4900T	Mini PCI Express	1x full-size mini PCI Express socket with internal SIM socket (mux with mSATA)
Chipset	Intel® Q370 Platform Controller Hub	M.2	1x M.2 2242 B key socket with dual front-accessible SIM sockets
Graphics	Integrated Intel® UHD Graphics 630	Expandable I/O	1x MeziO™ expansion port for Neosys MeziO™ modules
Memory	Up to 32 GB DDR4 2666/ 2400 SDRAM (two SODIMM slots)	Power Supply	
AMT	Supports AMT 12.0	DC Input	1x 3-pin pluggable terminal block for 8-35VDC DC input
TPM	Supports TPM 2.0	Remote Ctrl. & LED Output	1x 3-pin pluggable terminal block for remote control and PWR LED output
I/O Interface		Mechanical	
Ethernet	2x Gigabit Ethernet ports by I219 and I210 (Nuvo-7002LP) 6x Gigabit Ethernet ports by I219 and 5x I210 (Nuvo-7006LP)	Dimension	240 mm (W) x 225 mm (D) x 79 mm (H)
PoE+	Optional IEEE 802.3at PoE+ PSE for Port 3 - Port 6 100 W total power budget	Weight	3.1 kg
USB	4x USB 3.1 Gen2 (10 Gbps) ports 4x USB 3.1 Gen1 (5 Gbps) ports	Mounting	Wall-mounting (standard) or DIN-Rail mounting (optional)
Video Port (Integrated Graphics)	1x VGA connector, supporting 1920 x 1200 resolution 1x DVI-D connector, supporting 1920 x 1200 resolution 1x DisplayPort connector, supporting 4096 x 2304 resolution	Environmental	
Serial Port	2x software-programmable RS-232/422/485 ports (COM1/ COM2) 2x RS-232 ports (COM3/ COM4)	Operating Temperature	with 35W CPU -25°C - 70°C ** with 65W CPU -25°C - 70°C */** (configured as 35W TDP) -25°C - 50°C */** (configured as 65W TDP)
Audio	1x 3.5 mm jack for mic-in and speaker-out	Storage Temperature	-40°C - 85°C
Storage Interface		Humidity	10%-90% , non-condensing
SATA HDD	1x front-accessible, hot-swappable 2.5" HDD/ SSD tray 1x internal SATA port for 2.5" HDD/ SSD installation, supporting RAID 0/ 1	Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4
M.2	1x M.2 2280 M key socket (PCIe Gen3 x4) for NVMe SSD or Intel® Optane™ memory installation	Shock	Operating, MIL-STD-810G, Method 516.6, Procedure I, Table 516.6-II
mSATA	1x full-size mSATA port (mux with mini-PCIe)	EMC	CE/FCC Class A, according to EN 55032 & EN 55024

* For i7-8700 running at 65W mode, the highest operating temperature shall be limited to 50°C and thermal throttling may occur when sustained full-loading applied. Users can configure CPU power in BIOS to obtain higher operating temperature.

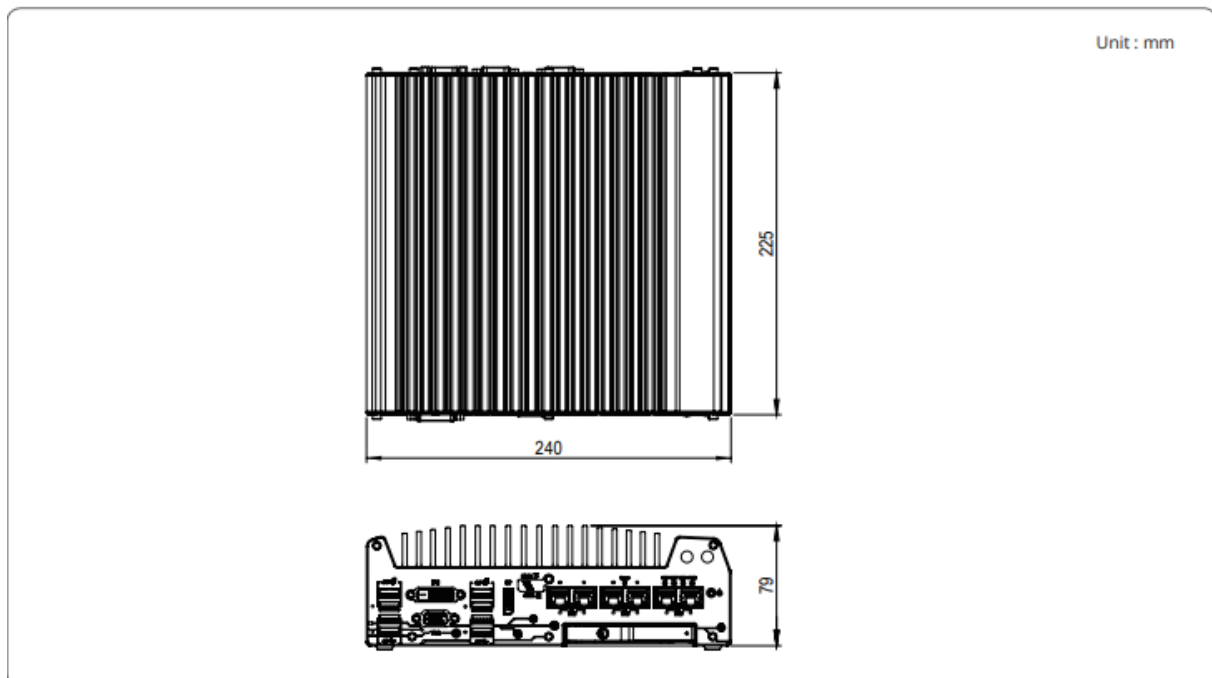
** For sub-zero operating temperature, a wide temperature HDD or Solid State Disk (SSD) is required.



Appearance



Dimensions



Ordering Information

Model No.	Product Description
Nuvo-7002LP	Intel® 8th-Gen Coffee Lake Core™ i7/i5/i3 fanless controller with 2x GbE ports, MeziO™ interface and low-profile chassis
Nuvo-7006LP	Intel® 8th-Gen Coffee Lake Core™ i7/i5/i3 fanless controller with 6x GbE ports, MeziO™ interface and low-profile chassis
Option of 802.3at PoE+ for GbE ports 3 ~ 6	

Optional Accessories

PA-160W-OW	160W AC/DC power adapter 20V/8A;18AWGx4C/120cm, cord end terminals for terminal block, operating temperature: -30°C to 70°C.
DINRAIL-O	DIN-rail mounting assembly for Nuvo-7000 series
MeziO™ Modules	
MeziO™-C180	MeziO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-232 ports
MeziO™-C181	MeziO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-422/ 485 ports
MeziO™-D220	MeziO™ module with 8-CH isolated digital input and 8-CH isolated digital output
MeziO™-D230	MeziO™ module with 16-CH isolated digital input and 16-CH isolated digital output
MeziO™-V20-EP	MeziO™ module with ignition power control function for in-vehicle application
MeziO™-U4	MeziO™ module with 4x USB3.0 ports
MeziO™-G4	MeziO™ module with 4x GigE ports
MeziO™-G4P	MeziO™ module with 4x IEEE 802.3at PoE ports